	7 S	Note QT:Qu	Unless other	3		REMARKS a	COUNT	SOLDERABILITY	SOLDERING HEAT	SULTUR DIOXIDE	TEMPERATURE	DAMP HEAT (STEADY STATE)	ENVIRONI	SHOCK	VIBRATION	MECHANICAL OPERATION	WITHDRAWAL FORCES	MECHANICAL	VOLTAGE PROOF	CONTACT RESISTANCE	FI FCTRIC		CONSTRUC				DATING
HIROSE	SP	QT:Qualification Test	Unless otherwise specified, refer to JIS-C-5402	THE RATED CURRENT,	"STORAGE" MEA	NCLUDE TEMPE			AT		Ť		ဂ				FORCES	_ CHAR/	RESISTANCE	ESISTANCE	⊣⊢	MINATION	RUCTION		CURRENT	VULIAGE	1
)SE ELE	ECIFICATION	AT:Assurance	ed, refer to	RENT APPLIE	NS A LONG-T	RATURE RISE	SCRIPTION	SOLDERED 240±3°C FC	PEAK TMF REFLOW SOLDERII	EXPOSED AT 25±2°C, 96 h. (TEST STANDARD: JIS	TEMPERATURE TIME UNDER 5 C' (RELOCATION TIN	EXPOSED AT	$\tilde{\tilde{c}}$	490 m/s ² , AT 3 TIN	FREQUENC SINGLE AM FOR 3 D	500 TIMES	MEASURED	CHARACTERISTICS	250 V DC	100 m	CONFIRMED TERRISTICS	VISUALLY A					_
ELECTRIC CO., LTD.	ATION SHEET	nce Test X:Applicable Test	JIS-C-5402.	(3) THE RATED CURRENT APPLIES TO PER CONTACT. APPLY 0.4A WHEN ALL THE CONTACTS ARE USED FOR CURRENT CARRYING	(2) "STORAGE" MEANS A LONG-TERM STORAGE STATE FOR THE UNUSED PRODUCT BEFORE ASSEMBLY TO PCB.	(*) INCLUDE TEMPERATURE RISE CAUSED BY CURRENT-CARRYING	DESCRIPTION OF REVISIONS	SOLDERED AT SOLDER TEMPERATURE 240±3°C FOR IMMERSION DURATION, 3	1)REFLOW SOLDERING: PEAK TMP: 260°CMAX REFLOW TMP: 220°CMIN FOR 60sec 2) SOLDERING IRONS: 360°C MAX. FOR 5	5±5%RH, 25 : 60068)	→ +85 °C → 30 mir :HAMBER:WITHII	°C, 90 ~ 95		IMES FOR 3 DIRECTIONS	FREQUENCY 10 TO 55 TO 10Hz, APPROX SINGLE AMPLITUDE: 0.75 mm, 10 CYCLES FOR 3 DIRECTIONS.	500 TIMES INSERTIONS AND EXTRACTIONS	MEASURED BY APPLICABLE CONNECTOR		250 V DC. 300 V AC FOR 1 min.	100 mA(DC OR 1000Hz)	CONFIRMED VISUALLY.	VISUALLY AND BY MEASURING INSTRUMENT.	TEST METHOD	SPECIF		O 5 A (SIGNAL CONTACT) (3)	<
COD	PAR:			RENT CARRYIN		YING.	DESI	N, 3 sec.	C OR 5 sec.	PPM FOR	2~3 MIN)	%, 96 h.		11 ms ONS.	PROX 5min CLES	ACTIONS.	CTOR.					RUMENT.		FICATIONS			_
CODE NO. CL	PART NO.	DRAWING NO.	DRAWN	To	CHECKED	APPROVED	DESIGNED	A NEW UNIFORM COATING OF SHALL COVER A MINIMUM OF SURFACE BEING IMMERSED.	NO DEFORMATION OF CASE EXCESSIVE LOOSENESS OF TERMINAL.	NO HEAVY CORROSION	© INSULATION RESISTANCE © INSULATION RESISTANCE :100 © NO DAMAGE, CRACK AND OF PARTS.	① CONTACT RESISTANCE: SIGNAL CONTACT : 100			 ① NO ELECTRICAL DISCONTINUITY 1 µs. ② NO DAMAGE, CRACK AND LOOSE 	① CONTACT RESISTANCE: SIGNAL CONTACT : 100 MF CONTACT : 40 ② NO DAMAGE, CRACK AN OF PARTS.	WITHDRAWAL FORCE:		1000 MΩMIN NO FLASHOVER OR	SIGNAL CONTACT		ACCORDING TO	RE		0	OPERATING HUMIDITY	0 > 0
579-00	FX18:		Ž	VED		VED		M COATIN A MINIMUN G IMMERS	OSENESS	RROSION.	N RESISTA	SISTA			RICAL DISC	RESISTANO NTACT : ST : E, CRACK	FORCE:		위를			TO DRAWING	REQUIREMENTS			TY	_
CL579-0007-9-00	3-140P-0. 8SH	15	TH. SANO	TH. SANO	KI. HIROKAWA	HS. OKAWA	CHECKED	IG OF SOLDER M OF 95 % OF THE SED.			: 40 m k MAX. RESISTANCE :1000 MΩ MIN. CRACK AND LOOSENESS	NCE: : 100 m \text{Q MAX.}			AL DISCONTINUITY OF	CONTACT RESISTANCE: SIGNAL CONTACT : 100 mΩMAX. MF CONTACT : 40 mΩMAX. NO DAMAGE, CRACK AND LOOSENESS OF PARTS.	80 N MAX.		BREAKDOWN.	90 m Ω MAX. 30 m Ω MAX.		VG.	NENTS		(NOT DEWED)		10 % TO 70
<u> 1/1</u>	-	9-00	11. 03. 24	11. 03. 24	11. 03. 24	11. 03. 24	DATE	×	×	×		×	-	×	×	×	×		× ×	×	×	+	QT AT	-	3	\ 85 ₀ \ max	O % ∅